

CLAIMS

1. A die cleaning method for removing a forming-material from a die used in forming the forming-material containing a binder, characterized by comprising the steps of: removing a part or all of the binder contained in the forming-material from the die; and removing the forming-material from the die.

10 2. The die cleaning method according to claim 1, wherein the step of removing a part or all of the binder is performed by heating the die.

15 3. The die cleaning method according to claim 2, wherein a heating temperature is in a range of 200 to 500°C.

20 4. The die cleaning method according to any one of claims 1 to 3, wherein the step of removing the forming-material is performed by spraying a fluid to the die at a pressure of 40 kg/cm² or less.

25 5. The die cleaning method according to any one of claims 1 to 4, wherein the die includes a member constituted of cemented carbide.

6. The die cleaning method according to any one of claims 1 to 5, wherein the die includes a member having

slits.